

**Amendments to the Specification:**

Please amend the specification as follows:

Please replace paragraph number [0001] under the title “Cross Reference to Related Applications” with the following rewritten paragraph:

[0001] This application is related to U.S. Patent Application No. 10/123,751, Attorney Docket No. 39153/529 (G1234), entitled USE OF ULTRA-LOW ENERGY ION IMPLANTATION (ULEII) TO FORM ALLOY LAYERS IN COPPER; U.S. Patent Application No. 09/994,400, Attorney Docket No. 39153/474 (G1179), entitled METHOD OF INSERTING ALLOY ELEMENTS TO REDUCE COPPER DIFFUSION AND BULK DIFFUSION; and U.S. Patent Application No. 09/994,397, Attorney Docket No. 39153/472 (G1177), entitled METHOD OF IMPLANTING COPPER BARRIER MATERIAL TO IMPROVE ELECTRICAL PERFORMANCE which are all assigned to the same assignee as this application.